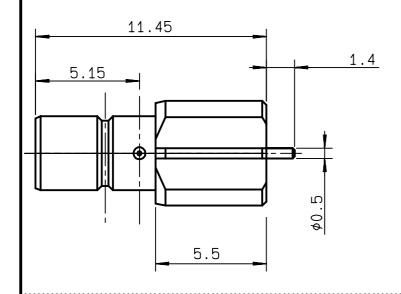
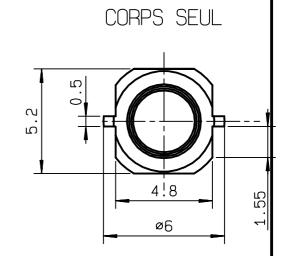
STRAIGHT PLUG RECEPTACLE FOR PCB SMT TYPE - EDGE CARD

R114.423.000

SERIES

SMB





NOMINAL IMPEDANCE

50

FREQUENCY RANGE

0-4 GHz

TEMPERATURE RATING

-65/+165 °C

V.S.W.R

1.05★ + .008 x F(GHz)Maxi

RF INSERTION LOSS

0.03★ √F(GHz) dB Maxi

VOLTAGE RATING

500 Veff Maxi

DIELECTRIC WITHSTANDING VOLTAGE 1000 Veff Mini

NA

1.3

INSULATION RESISTANCE

1000 M Ω Mini

HERMETIC SEAL

NA Atm.cm³/s : CABLE RETENTION

MECHANICAL DURABILITY

LEAKAGE (pressurized only)

WEIGHT

500 Cycles

SPECIFICATION

OTHERS CHARACTERISTICS

* COAXIAL TRANSMISSION LINE ONLY

NA N Mini

CENTER CONTACT RETENTION

Axial force - mating end

10 N Mini

: CABLES :

10 N Mini Axial force - opposite end

Torque

NA cm.N Mini

RECOMMENDED TORQUES

Mating

NA cm.N

Panel nut

NA cm.N

Clamp nut

cm.N

CONNECTOR PARTS:

MATERIALS

FINISH

GOLD 0.2 OVER NICKEL 2

(all values are given) in micrometers

BODY

OUTER CONTACT

BRASS

BRASS

GOLD 0.5 OVER NICKEL 2

INSULATOR **GASKET**

PTFE

OTHERS PIECES

ISSUE

9943C00

CENTER CONTACT

CREATION DATE

14/06/1994

FILE PART-NUMBER

EPC 94-04





R114.423.000

ISSUE 9943C00 SERIES SMB

SMB SERIES - INFORMATIONS SOLDER PROCEDURE OF RECEPTACLES IN INDUSTRIAL ENVIRONMENT

- 1 Deposit solder paste "Sn63Pb35Ag2" on mounting zone by screen printing application. We advise a thickness of 200 micromm (7.800 microinch). Verify that the edges of the zone are clean.
- 2 Deposit the receptacle on the mounting zone .

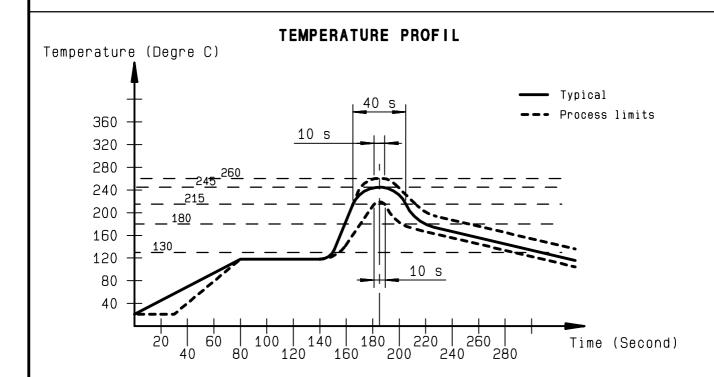
Video camera is prefered to check the positionning of the component.(See page 3)

Adhesive agents are forbidden on the receptacle.

- 3 Soldering by infra-red reflow.
 We give under, the typical profile to use.
- 4 Cleaning of printed circuit boards by CFC solvents (or a substitute product according to the United Nation's environmental programm).

We advise the vapor-phase method, with or without any ultrasonic waves. This cleaning is imperative for using the receptacle.

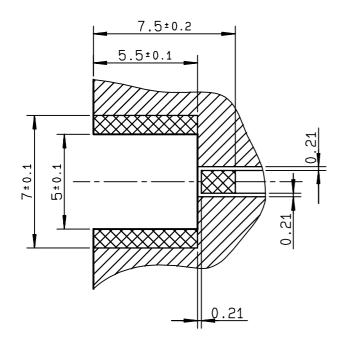
5 - Checking of solder joints and position of the component by visual inspection.





R114.423.000 ISSUE 9943C00 SERIES

SMB SERIE - INFORMATIONS



Pattern

Land for solder paste

COPLANAR LINE
Pattern and signal are on the same side
Thickness of PCB: .063 (1.6 mm)
The material of PCB is the epoxy resin
of glass fabrics bacs.(Er = 4.8)
The solder resist should be printed
exept for the land pattern on the PCB.

SHADOW OF SMB RECEPTACLE FOR VIDEO CAMERA

